Caracteristicas
La pasta BEST-Solder (Tin) es la mejor elección de reballing IC .original
Calidad verificada
Artículo: Pasta de soldadura BEST-506 50g

Rango de uso: computadora portátil / computadora / teléfono móvil / electrodomésticos
Reparación de SMD y BGA IC, herramientas para reparación a nivel de chip
Especificación

Junta de soldadura blanca y gruesa, soldadura sin falsa, adhesivo fuerte con punta de hierro de soldadura. Herramienta indispensable para la reparación precisa de equipos y la línea de fabricación electrónica.

Hay varios pesos por botella. por ejemplo, 50 g, 80 g, 250 g, etc.

PRODUCT DISPLAY

PRODUCT DETAILS

Name: Solder paste	Model: BST-506B
Size: Φ37*30mm	Weight: 50g
Composition: Sn63/Pb37	Melting point: 183℃

Storage:Chilled in refrigerator,the best refrigeration temperature is 5℃~10℃.

Features: 1. New technical support, unique chemical formula provides excellent wettability, ensuring high reliability.

2. Use highly effective thixotropic agents to effectively prevent the collapse of printing and preheating, and ensure good printing and fine pattern.

3. More advanced thermal insulation technology, adhesive durability, not easy to dry, sticky time up to 48 hours.

4. High quality, unique formulation, perfect performance, easy to weld, bright and full of welding spot, no such phenomenon as false welding or false welding.

5. The residue is colorless and transparent.It does not affect the monitoring, cleaning and cleaning performance.

6. Good moisturizing and dry resistance.Under normal temperature, the shelf life is longer, which is suitable for mobile phone maintenance, computer digital maintenance industry, high precision circuit board SMT welding, BGA process welding, etc.

PRODUCT PHOTOGRAPH

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